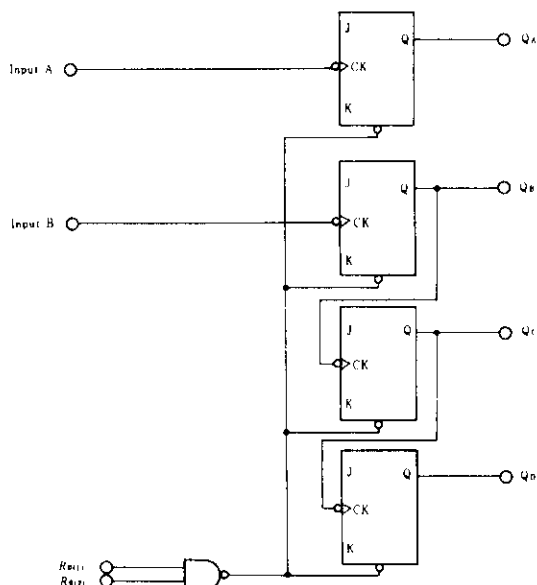


HD74LS93 4-bit Binary Counters

The HD74LS93 contains four master-slave flip-flops and additional gating to provide a divide-by-two counter and three-state binary counter for divide-by-eight. To use this maximum count length of this counter, the B input is connected to the Q_A output. The input count pulses are applied to input A and the outputs are described in the appropriate function table.

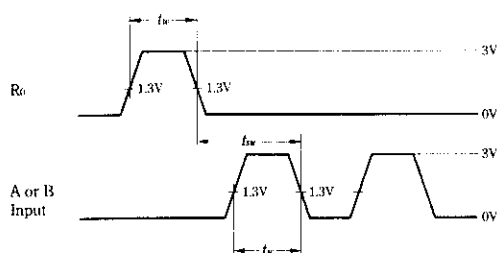
BLOCK DIAGRAM



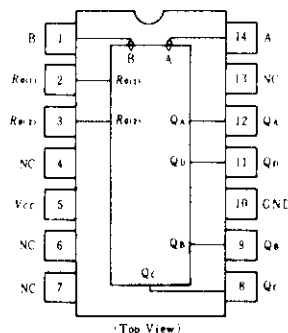
RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	Unit
Count frequency	A input	0	—	32	MHz
	B input	0	—	16	
Pulse width	A input	15	—	—	ns
	B input	30	—	—	
	Reset inputs	15	—	—	
Setup time	t_{su}	25	—	—	ns

TIMING DEFINITION



PIN ARRANGEMENT



ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Ratings	Unit
Supply voltage	V_{CC}	7.0	V
Input voltage	R Inputs	7.0	V
	A, B Inputs	5.5	V
Operating temperature range	T_{opr}	-20 ~ +75	°C
Storage temperature range	T_{stg}	-65 ~ +150	°C

FUNCTION TABLE

Reset/Count Function Table

Reset Inputs		Outputs			
$R0(1)$	$R0(2)$	Q_D	Q_C	Q_B	Q_A
H	H	L	L	L	L
L	X	Count			
X	L	Count			

BCD Count Sequence (Notes 1)

Count	Outputs			
	Q_D	Q_C	Q_B	Q_A
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	L	H	L	H
6	L	H	H	L
7	L	H	H	H
8	H	L	L	L
9	H	L	L	H
10	H	L	H	L
11	H	L	H	H
12	H	H	L	L
13	H	H	L	H
14	H	H	H	L
15	H	H	H	H

Notes) 1. Output Q_A is connected to input B for BCD count.
2. H; high level, L; low level, X; irrelevant

■ ELECTRICAL CHARACTERISTICS ($T_a = -20 \sim +75^\circ\text{C}$)

Item		Symbol	Test Conditions	min	typ*	max	Unit
Input voltage		V_{IH}		2.0	—	—	V
		V_{IL}		—	—	0.8	V
Output voltage		V_{OH}	$V_{CC}=4.75\text{V}$, $V_{IH}=2\text{V}$, $V_{IL}=0.8\text{V}$, $I_{OH}=-400\mu\text{A}$	2.7	—	—	V
		V_{OL}	$V_{CC}=4.75\text{V}$, $V_{IH}=2\text{V}$, $V_{IL}=0.8\text{V}$	$I_{OL}=4\text{mA}^{**}$	—	0.4	V
				$I_{OL}=8\text{mA}^{**}$	—	0.5	
Input current	Any Reset	I_{IL}	$V_{CC}=5.25\text{V}$, $V_I=0.4\text{V}$	—	—	-0.4	mA
	A input			—	—	-2.4	
	B input			—	—	-1.6	
	Any Reset	I_{IH}	$V_{CC}=5.25\text{V}$, $V_I=2.7\text{V}$	—	—	20	μA
	A input			—	—	40	
	B input			—	—	40	
	Any Reset	I_I	$V_{CC}=5.25\text{V}$	$V_I=7\text{V}$	—	0.1	mA
	A input			$V_I=5.5\text{V}$	—	0.2	
	B input			$V_I=5.5\text{V}$	—	0.2	
Short-circuit output current		I_{OS}	$V_{CC}=5.25\text{V}$	-20	—	-100	mA
Supply current		I_{CC}^{***}	$V_{CC}=5.25\text{V}$	—	9	15	mA
Input clamp voltage		V_{IK}	$V_{CC}=4.75\text{V}$, $I_{IN}=-18\text{mA}$	—	—	-1.5	V

* $V_{CC}=5\text{V}$, $T_a=25^\circ\text{C}$

** Q_A output is tested at specified I_{OL} plus the limit value of I_{IL} for the B input. This permits driving the B input while maintaining full fan-out capability.

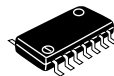
*** I_{CC} is measured with all outputs open, both R_0 inputs grounded following momentary connection to 4.5V, and all other inputs grounded.

■ SWITCHING CHARACTERISTICS ($V_{CC}=5\text{V}$, $T_a=25^\circ\text{C}$)

Item	Symbol	Inputs	Outputs	Test Conditions	min	typ	max	Unit
Maximum count frequency	f_{max}	A	Q_A	$C_L=15\text{pF}, R_L=2\text{k}\Omega$	32	42	—	MHz
		B	Q_B		16	—	—	
Propagation delay time	t_{PLH}	A	Q_A		—	10	16	ns
	t_{PHL}				—	12	18	
	t_{PLH}	A	Q_D		—	46	70	ns
	t_{PHL}				—	46	70	
	t_{PLH}	B	Q_B		—	10	16	ns
	t_{PHL}				—	14	21	
	t_{PLH}	B	Q_C		—	21	32	ns
	t_{PHL}				—	23	35	
	t_{PLH}	B	Q_D		—	34	51	ns
	t_{PHL}				—	34	51	
	t_{PHL}	Set-to-0	$Q_A \sim Q_D$		—	26	40	ns

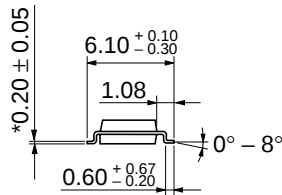


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Weight (reference value)	0.97 g



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*Dimension including the plating thickness
Base material dimension



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EIAJ	Conforms
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